

## Dual N-Channel 20 V (D-S) MOSFET

### PRODUCT SUMMARY

| $V_{DS}$ (V) | $R_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) | $Q_g$ (Typ.) |
|--------------|---------------------------|-----------|--------------|
| 20           | 0.396 at $V_{GS} = 4.5$ V | 0.5       | 0.75         |
|              | 0.456 at $V_{GS} = 2.5$ V | 0.2       |              |
|              | 0.546 at $V_{GS} = 1.8$ V | 0.2       |              |
|              | 0.760 at $V_{GS} = 1.5$ V | 0.05      |              |

### FEATURES

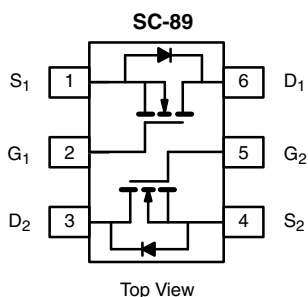
- TrenchFET® Power MOSFET
- 100 %  $R_g$  Tested
- Gate-Source ESD Protected: 1000 V
- Material categorization:  
For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



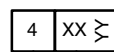
**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Load/Power Switching for Portable Devices
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits



Marking Code



Lot Traceability  
and Date Code

Part # Code

**Ordering Information:** Si1034CX-T1-GE3 (Lead (Pb)-free and Halogen-free)

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)

| Parameter                                               | Symbol         | Limit       | Unit |
|---------------------------------------------------------|----------------|-------------|------|
| Drain-Source Voltage                                    | $V_{DS}$       | 20          | V    |
| Gate-Source Voltage                                     | $V_{GS}$       | $\pm 8$     |      |
| Continuous Drain Current ( $T_J = 150$ °C) <sup>a</sup> | $T_A = 25$ °C  | $I_D$       | A    |
|                                                         | $T_A = 70$ °C  |             |      |
| Pulsed Drain Current                                    | $I_{DM}$       | 2           |      |
| Continuous Source-Drain Diode Current                   | $T_A = 25$ °C  | $I_S$       | A    |
| Maximum Power Dissipation <sup>a</sup>                  | $T_A = 25$ °C  | $P_D$       | W    |
|                                                         | $T_A = 70$ °C  |             |      |
| Operating Junction and Storage Temperature Range        | $T_J, T_{stg}$ | - 55 to 150 | °C   |

### THERMAL RESISTANCE RATINGS

| Parameter                                | Symbol     | Typ. | Max. | Unit |
|------------------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient <sup>b</sup> | $R_{thJA}$ | 470  | 565  | °C/W |
|                                          |            | 560  | 675  |      |

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b.  $t = 5$  s.

**SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

| Parameter                                     | Symbol                  | Test Conditions                                                                                                                    | Min. | Typ.  | Max.     | Unit          |
|-----------------------------------------------|-------------------------|------------------------------------------------------------------------------------------------------------------------------------|------|-------|----------|---------------|
| Static                                        |                         |                                                                                                                                    |      |       |          |               |
| Drain-Source Breakdown Voltage                | $V_{DS}$                | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                             | 20   |       |          | V             |
| $V_{DS}$ Temperature Coefficient              | $\Delta V_{DS}/T_J$     | $I_D = 250\text{ }\mu\text{A}$                                                                                                     |      | 17    |          | mV/°C         |
| $V_{GS(th)}$ Temperature Coefficient          | $\Delta V_{GS(th)}/T_J$ |                                                                                                                                    |      | - 1.8 |          |               |
| Gate-Source Threshold Voltage                 | $V_{GS(th)}$            | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                 | 0.4  |       | 1        | V             |
| Gate-Source Leakage                           | $I_{GSS}$               | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 8\text{ V}$                                                                                  |      |       | $\pm 30$ | $\mu\text{A}$ |
|                                               |                         | $V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 4.5\text{ V}$                                                                                |      |       | $\pm 1$  |               |
| Zero Gate Voltage Drain Current               | $I_{DSS}$               | $V_{DS} = 20\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                     |      |       | 1        |               |
|                                               |                         | $V_{DS} = 20\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 85\text{ }^{\circ}\text{C}$                                                |      |       | 3        |               |
| On-State Drain Current <sup>a</sup>           | $I_{D(on)}$             | $V_{DS} = \geq 5\text{ V}$ , $V_{GS} = 4.5\text{ V}$                                                                               | 2    |       |          | A             |
| Drain-Source On-State Resistance <sup>a</sup> | $R_{DS(on)}$            | $V_{GS} = 4.5\text{ V}$ , $I_D = 0.5\text{ A}$                                                                                     |      | 0.330 | 0.396    | $\Omega$      |
|                                               |                         | $V_{GS} = 2.5\text{ V}$ , $I_D = 0.2\text{ A}$                                                                                     |      | 0.380 | 0.456    |               |
|                                               |                         | $V_{GS} = 1.8\text{ V}$ , $I_D = 0.2\text{ A}$                                                                                     |      | 0.420 | 0.546    |               |
|                                               |                         | $V_{GS} = 1.5\text{ V}$ , $I_D = 0.05\text{ A}$                                                                                    |      | 0.505 | 0.760    |               |
| Forward Transconductance                      | $g_{fs}$                | $V_{DS} = 10\text{ V}$ , $I_D = 0.5\text{ A}$                                                                                      |      | 7.5   |          | S             |
| Dynamic <sup>b</sup>                          |                         |                                                                                                                                    |      |       |          |               |
| Input Capacitance                             | $C_{iss}$               | $V_{DS} = 10\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$                                                                |      | 43    |          | pF            |
| Output Capacitance                            | $C_{oss}$               |                                                                                                                                    |      | 14    |          |               |
| Reverse Transfer Capacitance                  | $C_{rss}$               |                                                                                                                                    |      | 8     |          |               |
| Total Gate Charge                             | $Q_g$                   | $V_{DS} = 10\text{ V}$ , $V_{GS} = 8\text{ V}$ , $I_D = 0.6\text{ A}$                                                              |      | 1.3   | 2        | nC            |
|                                               |                         | $V_{DS} = 10\text{ V}$ , $V_{GS} = 4.5\text{ V}$ , $I_D = 0.6\text{ A}$                                                            |      | 0.75  | 1.2      |               |
| $Q_{gs}$                                      |                         |                                                                                                                                    | 0.15 |       |          |               |
| $Q_{gd}$                                      |                         |                                                                                                                                    | 0.13 |       |          |               |
| Gate Resistance                               | $R_g$                   | $f = 1\text{ MHz}$                                                                                                                 | 2.4  | 12.2  | 24.4     | $\Omega$      |
| Turn-On Delay Time                            | $t_{d(on)}$             | $V_{DD} = 10\text{ V}$ , $R_L = 20\text{ }\Omega$<br>$I_D \cong 0.5\text{ A}$ , $V_{GEN} = 4.5\text{ V}$ , $R_g = 1\text{ }\Omega$ |      | 11    | 20       | ns            |
| Rise Time                                     | $t_r$                   |                                                                                                                                    |      | 16    | 24       |               |
| Turn-Off Delay Time                           | $t_{d(off)}$            |                                                                                                                                    |      | 26    | 39       |               |
| Fall Time                                     | $t_f$                   |                                                                                                                                    |      | 11    | 20       |               |
| Drain-Source Body Diode Characteristics       |                         |                                                                                                                                    |      |       |          |               |
| Pulse Diode Forward Current <sup>a</sup>      | $I_{SM}$                |                                                                                                                                    |      |       | 2        | A             |
| Body Diode Voltage                            | $V_{SD}$                | $I_S = 0.5\text{ A}$                                                                                                               |      | 0.8   | 1.2      | V             |
| Body Diode Reverse Recovery Time              | $t_{rr}$                | $I_F = 0.5\text{ A}$ , $dI/dt = 100\text{ A}/\mu\text{s}$                                                                          |      | 10    | 15       | ns            |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$                |                                                                                                                                    |      | 2     | 4        | nC            |
| Reverse Recovery Fall Time                    | $t_a$                   |                                                                                                                                    |      | 5     |          | ns            |
| Reverse Recovery Rise Time                    | $t_b$                   |                                                                                                                                    |      | 5     |          |               |

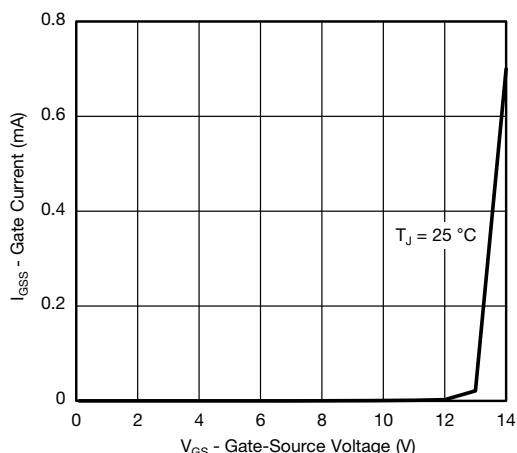
## Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

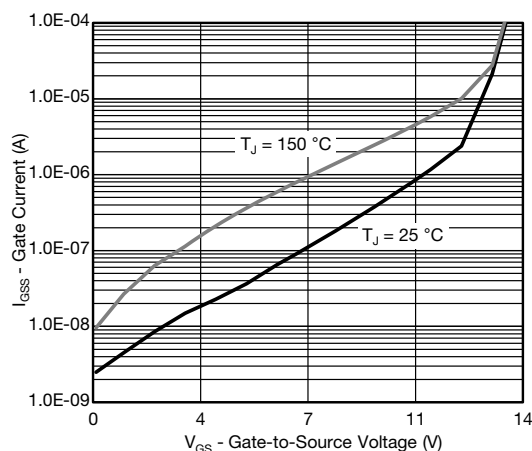
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

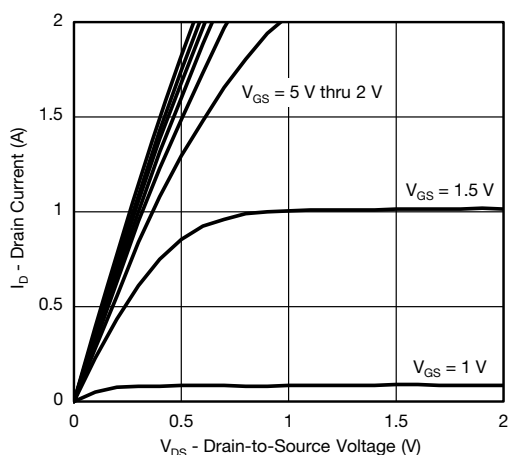
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



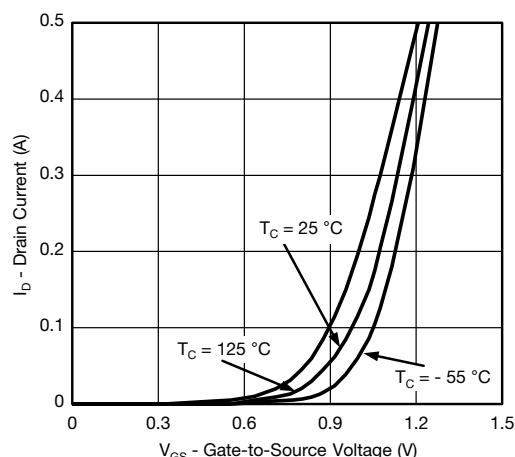
Gate Current vs. Gate-Source Voltage



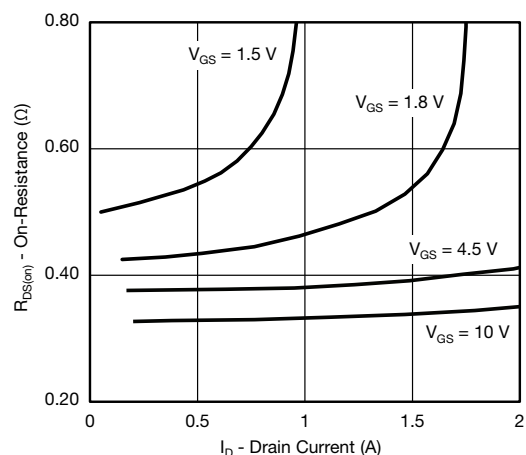
Gate Current vs. Gate-Source Voltage



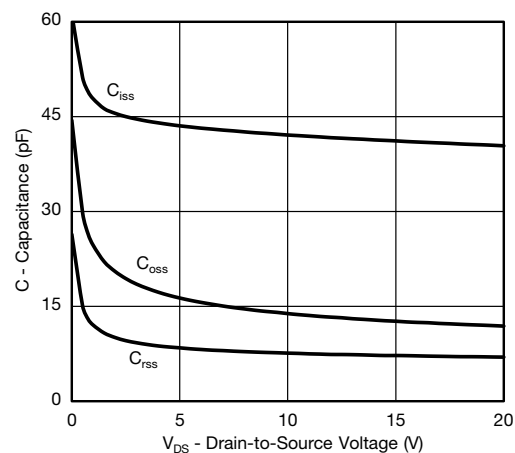
Output Characteristics



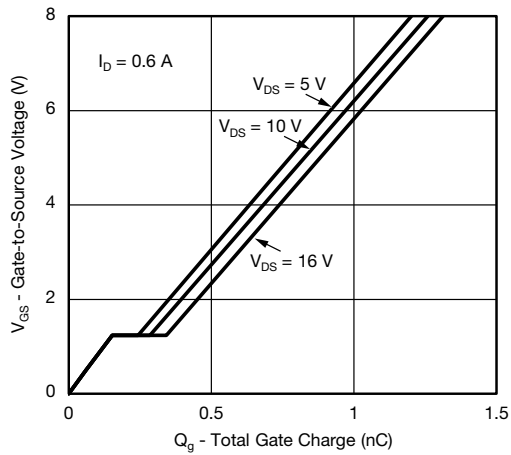
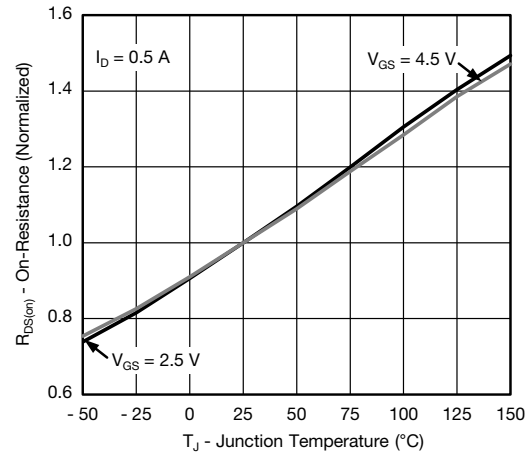
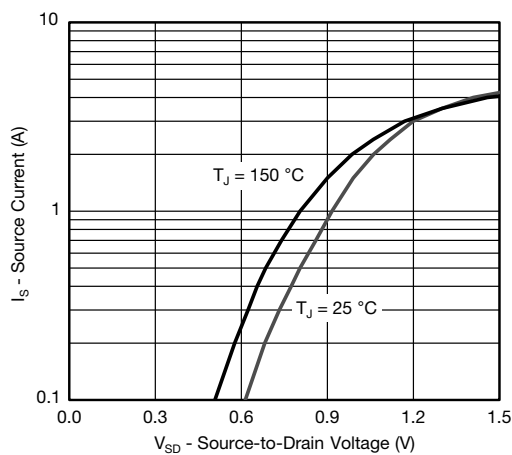
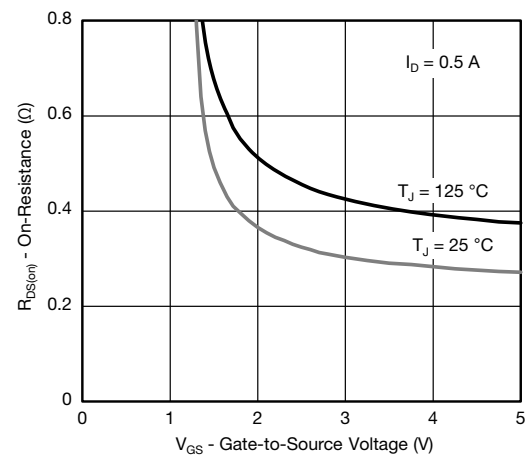
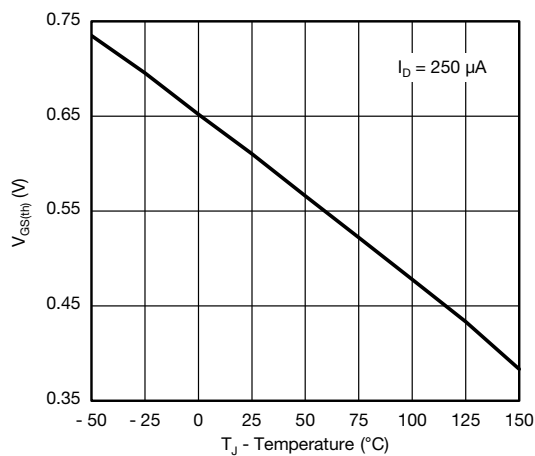
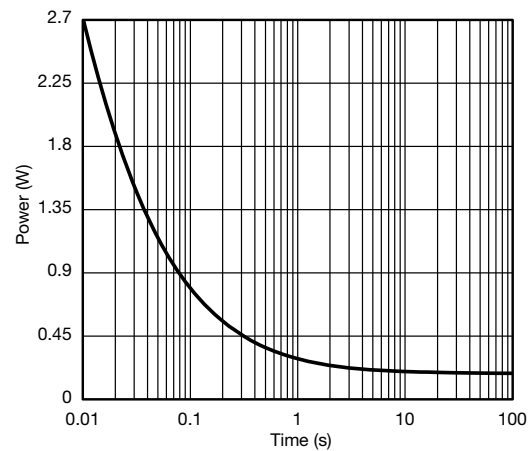
Transfer Characteristics



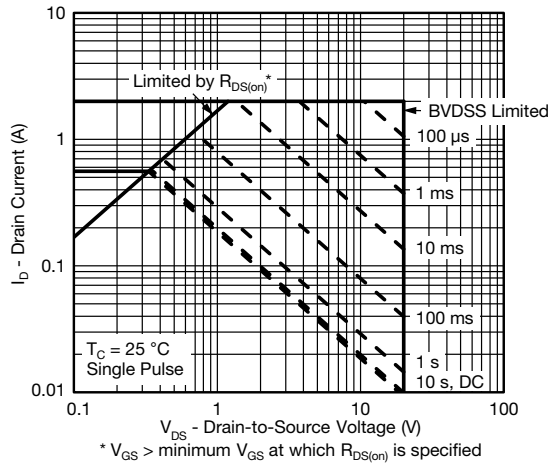
On-Resistance vs. Drain Current



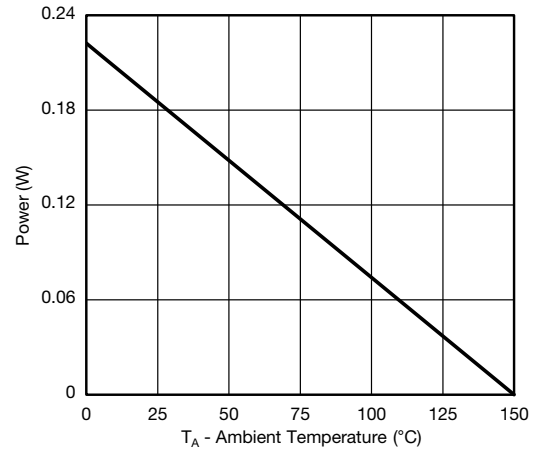
Capacitance

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)**Gate Charge****On-Resistance vs. Junction Temperature****Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power, Junction-to-Ambient**

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

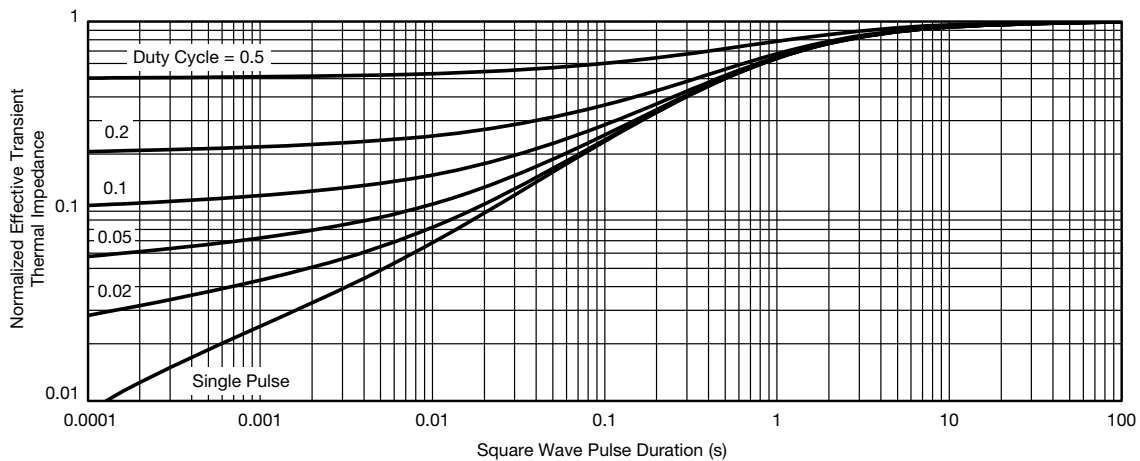


Safe Operating Area, Junction-to-Ambient



Power Derating, Junction-to-Ambient

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient

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## SC-89 6-Leads (SOT-563F)



## Notes

1. Dimensions in millimeters.
2. Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
3. Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
4. Datums A, B and D to be determined 0.10 mm from the lead tip.
5. Terminal numbers are shown for reference only.
6. These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

| DIM. | MILLIMETERS |      |      |
|------|-------------|------|------|
|      | MIN.        | NOM. | MAX. |
| A    | 0.56        | 0.58 | 0.60 |
| A1   | 0           | 0.02 | 0.10 |
| b    | 0.15        | 0.22 | 0.30 |
| c    | 0.10        | 0.14 | 0.18 |
| D    | 1.50        | 1.60 | 1.70 |
| E    | 1.50        | 1.60 | 1.70 |
| E1   | 1.15        | 1.20 | 1.25 |
| e    | 0.45        | 0.50 | 0.55 |
| e1   | 0.95        | 1.00 | 1.05 |
| L    | 0.25        | 0.35 | 0.50 |
| L1   | 0.10        | 0.20 | 0.30 |

C14-0439-Rev. C, 11-Aug-14  
DWG: 5880

## RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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